

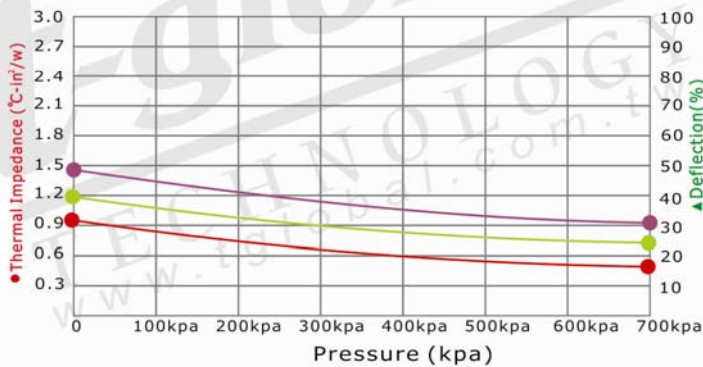
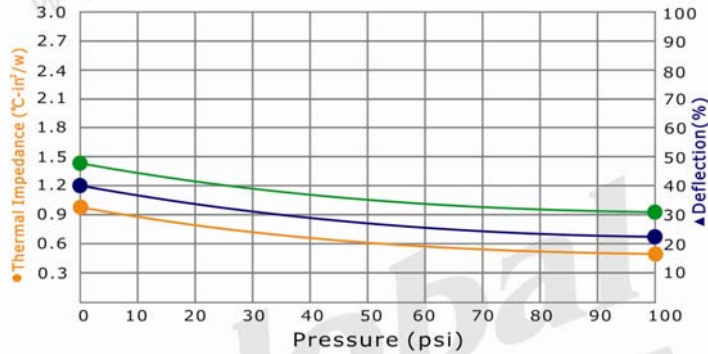
L37-3F Thermal Conductive Pad

Feature 特性

- Good thermal conductivity 良好的導熱性
- Easy to assemble 容易施工
- Good insulator 超高耐電壓
- Carrier: Fiberglass 載體: 玻纖

Application 產品應用端

- Electronic components: IC、CPU、MOS、LED、M/B、P/S、Heat Sink.
- LCD-TV、Notebook PC、PC、Telecom Device、Wireless Hub..... etc.
- DDR II Module、DVD Applications、Hand-set applications.....etc.

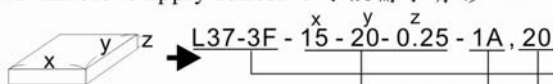


Testing sample thickness: 0.25/0.3/0.45mm

In "Thermal resistance V.S. Pressure V.S. Deflection" chart, L37-3F provide low thermal impedance. The pressure gets higher, the thermal impedance gets lower, and deflection percentage gets higher. L37-3F provide good compliance and softness.

Property	L37-3F	Unit	Tolerance	Test
Color 顏色	Yellow 黃色	-	-	Visual
Thickness 厚度	0.25 / 0.3 / 0.45	mm 公厘	-	ASTM D374
	0.0098 / 0.0118 / 0.0177	inch 公吋	-	ASTM D374
Thermal Conductivity 導熱係數	1.4	W/m.k	-	ASTM D5470
Flame Rating 耐燃等級	V-0	-	-	UL 94
Insulation Strength 耐電壓值	3 / 4 / 5	kv	-	ASTM D149
Weight Loss 重量損失	<1	%	-	ASTM E595
Specific Gravity 比重	2.0	g/cm ³	±0.2	ASTM D792
Working Temperature 工作溫度	-40 ~ +200	°C	-	-
Volume Resistance 體積阻抗	10 ¹³	ohm-cm	-	ASTM D257
Elongation 延展率	5	%	±13	ASTM D412
Tensile Strength 抗拉強度	150	Kgf/cm ²	±2	ASTM D412
Standard Shape 標準形狀	-	Sheet ones 單片狀	-	-
Hardness 硬度	80	Shore A	±5	ASTM D2240
REACH Compliant 符合REACH 規範	Yes 是	RoHS Compliant 符合RoHS 規範		Yes 是

- Available to apply adhesive 可依需求背膠
- Pre-cut for different shape 可依需求沖型裁切
- Need sample? 樣品需求



- Choose the P/N.
- Fill the size: x, y, z.
- Apply the adhesive or not? 0=none, 1A=one side, 2A= two sides.
- Fill the quantity you need.

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